

MAINTENANCE MANUAL

JW SERIES

CONTENTS

1. INTRODUCTION

2. SPECIFICATIONS

- 2.1 SYSTEM BLOCK DIAGRAM
- 2.2 PHYSICAL LAYOUT OF ELECTRICAL CONNECTION
- 2.3 GENERAL SPECIFICATIONS
- 2.4 OPTIONAL INTERFACE
- 2.5 INTERNAL SETTINGS AND CALIBRATION METHODS

3. TROUBLE SHOOTING

- 3.1 TROUBLE SHOOTING LOOP
- 3.2 PARTS AND COMPONENTS TROUBLE SHOOTING

4. ELECTRICAL CIRCUITRY

- 4.1 SCHEMATICS
- 4.2 PCB LAYOUT

5. BILL OF MATERIAL

6. APPENDIX: - EXPLOSION DIAGRAM

NOVEMBER 2004

Specifications and Function Subject to Change without Notice

1. INTRODUCTION

This maintenance manual contains of certain information that may result in fraudulent use. Do not release any part of this manual to any end users or un-authorized persons.

End users should be advised not to undertake any trouble shooting except those listed on the operation manual.

The internal **MINI JUMPER** should be so set to prevent un-authorized settings or alternations.

Should a load cell has been replaced, make sure that the protection devices are properly set.

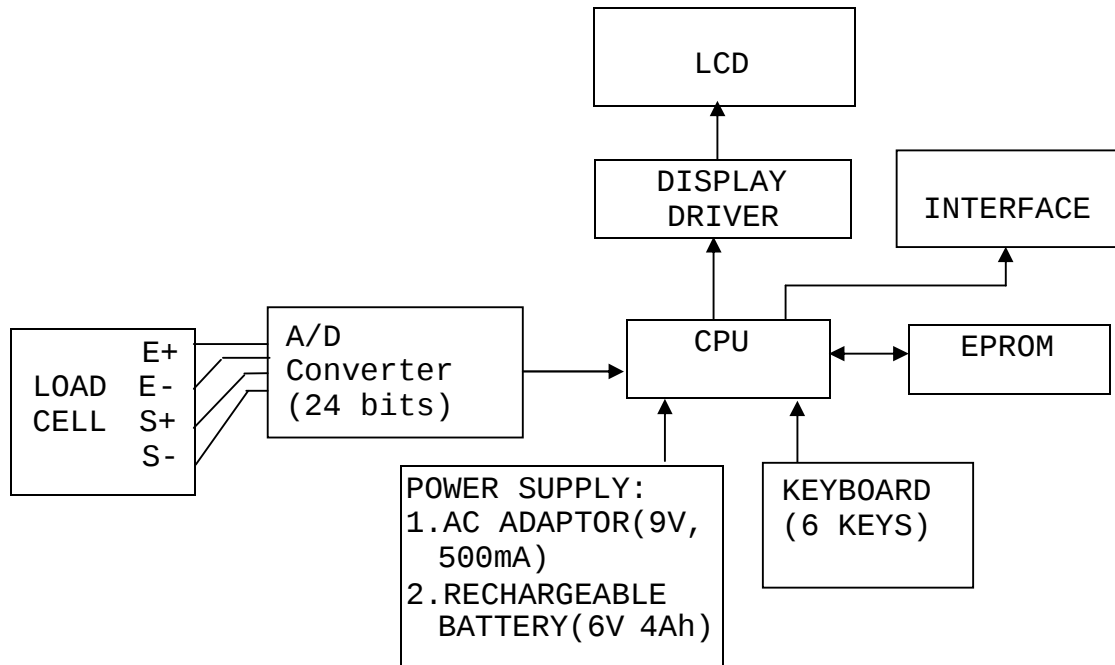
After servicing, it is necessary to go through all tests and procedures to ensure the scale meets all the metrological and approval requirements.

Here are some features of the JW series

1. Zero indicator
2. Tare indicator
3. Negative value indicator
4. Subtractive tare function
5. Power on zero function
6. Manual zero function
7. Power saving function
8. Low battery warning signal
9. Counting & percentage functions included
10. 1/30000 or 1/50000 display resolution
11. Metric unit + 12 user programmable weight units
12. 6 x 19mm digits bold type LCD display
13. Power source: by 6V 3Ah rechargeable battery or AC adaptor
14. 2 types of calibration
15. Equipped with RS232 interface & backlight facility
16. Bubble level included
17. Wind shield included(JW-250,300,500,600,1000)

2. SPECIFICATION

2.1 SYSTEM BLOCK DIAGRAM



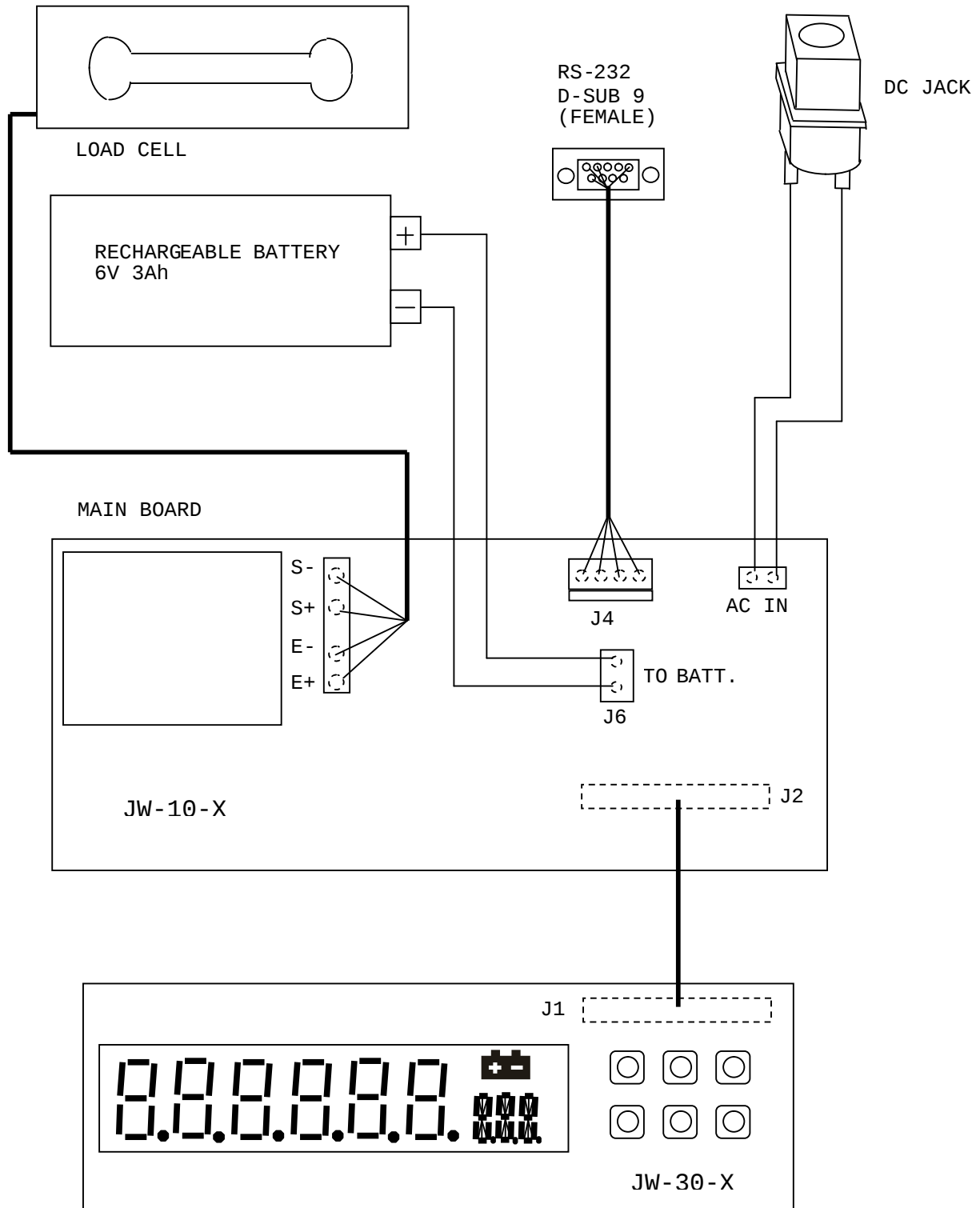
Description:

When an article is placed on the platter, the load of the article is applied to the load cell inside the scale.

The resistance to the excitation current in the strain gauge will then changed and the analog output signal varies.

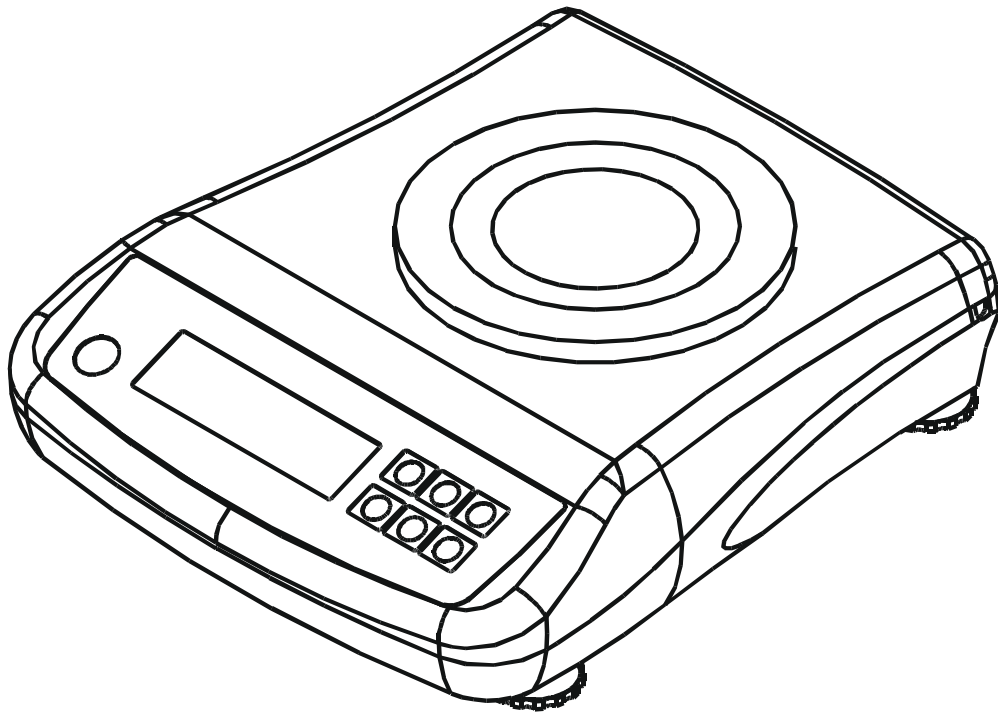
It is amplified and digitized continuously by the A/D converter into a digital signal. Subsequently, the resulting count is processed and managed by the CPU. The CPU refers to the instructions from the keyboard, and then conveys the output data to display driver, which formats the data into readout on the display panels.

2.2 PHYSICAL LAYOUT OF ELECTRICAL CONNECTION



2.3 GENERAL SPECIFICATIONS

2.3.1 Overall View



2.3.2 Overall Dimension:

220(W) X 224(D) X 70(H)mm Max.

2.3.3 Technical Specifications

Model No.	Capacity (Max)	Division (e)
1/50000		
JW-250	250g	0.005g
JW-500	500g	0.01g
JW-1000	1000g	0.02g
JW-2500	2500g	0.05g
1/30000		
JW-300	300g	0.01g
JW-600	600g	0.02g
JW-1500	1500g	0.05g
JW-3000	3000g	0.1g
Tare Range	Full Tare Range	
Power-on Zero Range	Full Power-on Zero Range	
Zero Range	±2%	
Min. Load	20e	
Weighing Units NOTE A	Gram, ounce, pound, troy ounce, grain, penny weight, metric carat, momme, troy tael, tola, dram	
Power Source	By Built-in Rechargeable Battery or AD/DC Power Adaptor	
Operating Environment	0°~40°C (32°~104°F), Non-condensed. R.H. ≤ 85%	
Weight	N.W. 2.0kg, G.W. 3.0kg	

NOTE A:

To comply with the law of certain countries, the some of the weighing units may be disabled. Contact your dealer for more information.

2.3.4 Main Components Used

Microprocessors: SM8958A

Crystal Oscillator: 11.0592MHz

Display Device: WIDE ANGLE LCD DISPLAY

Load Cell Capacity:	JW-250/300	=	BCL-300g
	JW-500/600	=	BCL-600g
	JW-1000/1500	=	BCL-1200g
	JW-2500/3000	=	BCL-3000g

2.3.5 Analog Specification

- Power supply of 5 V DC;
- Excitation power supply for the load cell is 5 V DC;
- Input impedance of the load cell is 350 Ω ;
- Rated output of load cell is 1mV/V;
- The analog data processing unit is built in a closed metal box.
- 24 bits A/D converter
- A/D Conversion Speed: 20 times/second
- Internal Resolution: 1,000,000 counts

2.4 OPTIONAL INTERFACE

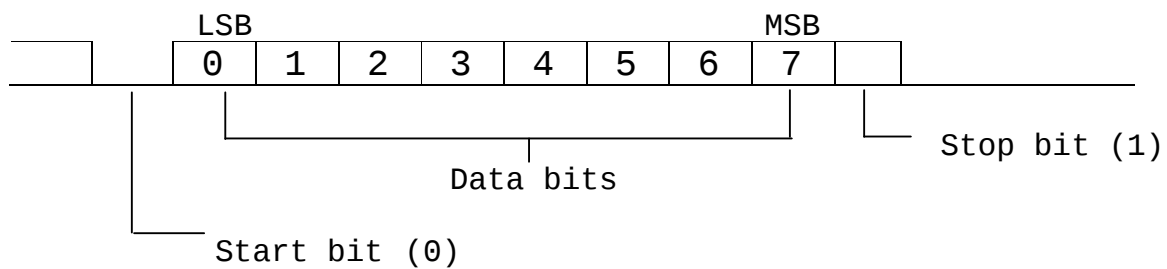
2.4.1 Serial RS-232C Port (D-SUB 9 pin)

RS232 PIN ASSIGNMENT

PIN NUMBER	ASSIGNMENT
1	CD
2	TXD
5	GND
6	DSR
7	RTS
8	CTS

Remarks:

- RTS & CTS are short-circuited internally.
- Should computer signal input end consists of DSR & CD signal check cable, then short circuit pin 1, 6, 7 & 8.



Type : EIA-RS-232C

Method : Half-duplex, asynchronous transmission

Format :

Baud rate : 4800, 9600 or 19200

Data bit : 8

Parity bit : None

Stop bit : 1

Code : ASCII

Transmission mode : CONTINUOUS TRANSMISSION

Data format

WEIGHT (include sign)								SPACE	UNIT			CR	LF
1	2	3	4	5	6	7	8	9	10	11	12	13	14

2.5 INTERNAL SETTINGS AND CALIBRATION PROCEDURES

7 internal settings are available as below table.

Function	Symbol	Description
0	F.0	Compulsory zero display
1	F.1	Offset value Reading
2	F.2	Full display Segment
3	F.3	Select weight unit
4	F.4	Auto power off setting
5	F.5	Baud rate setting
6	F.6	Motion filter speed setting

2.5.1 How to Enter the Functions Required

- Turn scale on by pressing **ON/RE-ZERO**, then press and hold **%/WT.** before scale completes counting down
- The display shows **F.1**
- Press **%/WT.** until the desired function number appears
- Press **MODE** to enter selection
- Press **MODE** to select setting value
- Press **%/WT.** to confirm setup
- Turn scale off and on again to use it as normal

2.5.2 Compulsory Zero Display (F.0)

A zero weight value will be displayed on the scale if the load detected is within the below range.

Symbol	Zero Value Display Range
2Ero_0	±0.5e
2Ero_1	±1.0e
2Ero_2	±1.5e
2Ero_3	±2.0e
2Ero_4	±2.5e

2.5.3 Offset Value Reading (F.1)

- Remove all loads from platter

2. Enter **F.1** through procedures as described in **2.5.1**
3. The offset value is displayed on the scale

2.5.4 Full Display Segment (F.2)

1. Enter **F.2**
2. Press **MODE**
3. All display segments will be lighted up
4. Check digits and arrow indications to verify any defects or errors
5. Press **%/WT.** to quit

2.5.5 Select Weight Unit (F.3)

1. Enter **F.3**
2. Press **MODE** to select the weighing unit according to the mode indicator
3. Press **PCS/WT.** to turn on or off the selected units
4. To set power on initial unit, press **SAMPLE** when at the selected unit
5. Press **%/WT.** to confirm setup

2.5.6 Auto Power Off Setting (F.4)

This unit is equipped with **AUTO POWER OFF** function. Default setting = auto off after 30 minutes unused. Follow the below steps to disable/employ the **AUTO POWER OFF** function.

1. Refer to the **2.5.1** on how to enter **F.4**
2. Press **MODE** to shift between **0_OFF** and **30_OFF**
*To disable the **AUTO POWER OFF** function select "**0_OFF**"
*To employ the **AUTO POWER OFF** function select "**30_OFF**"
3. Press **%/WT.** to confirm and return to other function selection manual

2.5.7 Select RS-232 Baud Rate(F.5)

This unit equipped with 3 baud rates with default setting at 9600 and N.8.1. Follow the below steps to select the desire speed.

1. Enter **F.5**
2. Press **MODE** to select among **br 48**, **br 96** or **br192**
3. Press **%/WT.** to confirm setup

2.5.8 Motion Filter Speed Setting (F.6)

Motion filter is used to give a more stable display when the working environment is affected by motion or airflow interference. Refer to

the below table for motion filter speed setting

Symbol	Motion Filter Speed
Filt_0	Disable (Normal)
Filt_1	Minimum
Filt_2	Medium
Filt_3	High
Filt_4	Maximum

2.5.9 AUTO AND DEALER CALIBRATION PROCEDURES

2.5.9.1 Calibration load and span value range

Model No.		CAL_1		CAL_2	
	OFFSET (Thousand)	LOAD APPLIED	SPAN RANGE (Thousand)	LOAD APPLIED	SPAN RANGE (Thousand)
JW-250	40~200	100g	200~300	250g	500~750
JW-500	40~200	200g	200~300	500g	500~750
JW-1000	40~200	500g	200~300	1000g	500~750
JW-2500	40~200	1000g	200~300	2500g	500~750
JW-300	40~200	100g	200~300	300g	600~900
JW-600	40~200	200g	200~300	600g	600~900
JW-1500	40~200	500g	200~300	1500g	600~900
JW-3000	40~200	1000g	200~300	3000g	600~900

To increase the span value: - Decrease the impedance value of R5

To decrease the span value: - Increase the impedance value of R5

Dealer Calibration Procedures

1. Hold %/WT. and press **ON/RE-ZERO** to turn on the scale.
2. "F.1" will appear on WEIGHT panel.
3. Press **MODE** twice to enter calibration.
4. Scale now displays "CAL._1", press **MODE** again to confirm
5. WEIGHT panel will display "YES" then "CAL. 0" to automatically calibrate the zero point.
6. When it completes in calibrating zero point, it will automatically enter the next step.

7. WEIGHT panel will now keep flashing a standard calibrate weight to prompt user placing the mass onto the platter.
8. Load the mass.
9. Scale will have a beep sound when it is calibrated.
10. WEIGHT panel now displays "CAL._2"
11. There are two options now, either press **OFF** to exit the calibration or press **MODE** to enter second point calibration.
12. When **MODE** is pressed, scale will display "yES" and ask to load the second weight, which is normally close to the maximum capacity.
13. Load the mass.
14. Scale will automatically exit the calibration procedure when it is calibrated.
15. Scale now reads the weight of the load on the platter.

Auto Calibration Procedures

1. Hold **MODE** and press **ON/RE-ZERO** to turn on the scale.
2. "CAL._1" will appear on WEIGHT panel.
3. Press **MODE** again to enter calibration.
4. WEIGHT panel will display "yES" then "CAL. 0" to automatically calibrate the zero point.
5. When it completes in calibrating zero point, it will automatically enter the next step.
6. WEIGHT panel will now keep flashing a standard calibrate weight to prompt user placing the mass onto the platter.
7. Load the mass.
8. Scale will have a beep sound when it is calibrated.
9. WEIGHT panel now displays "CAL._2"
10. There are two options now, either press **OFF** to exit the calibration or press **MODE** to enter second point calibration.
11. When **MODE** is pressed, scale will display "yES" and ask to load the second weight, which is normally close to the maximum capacity.

12. Load the mass.

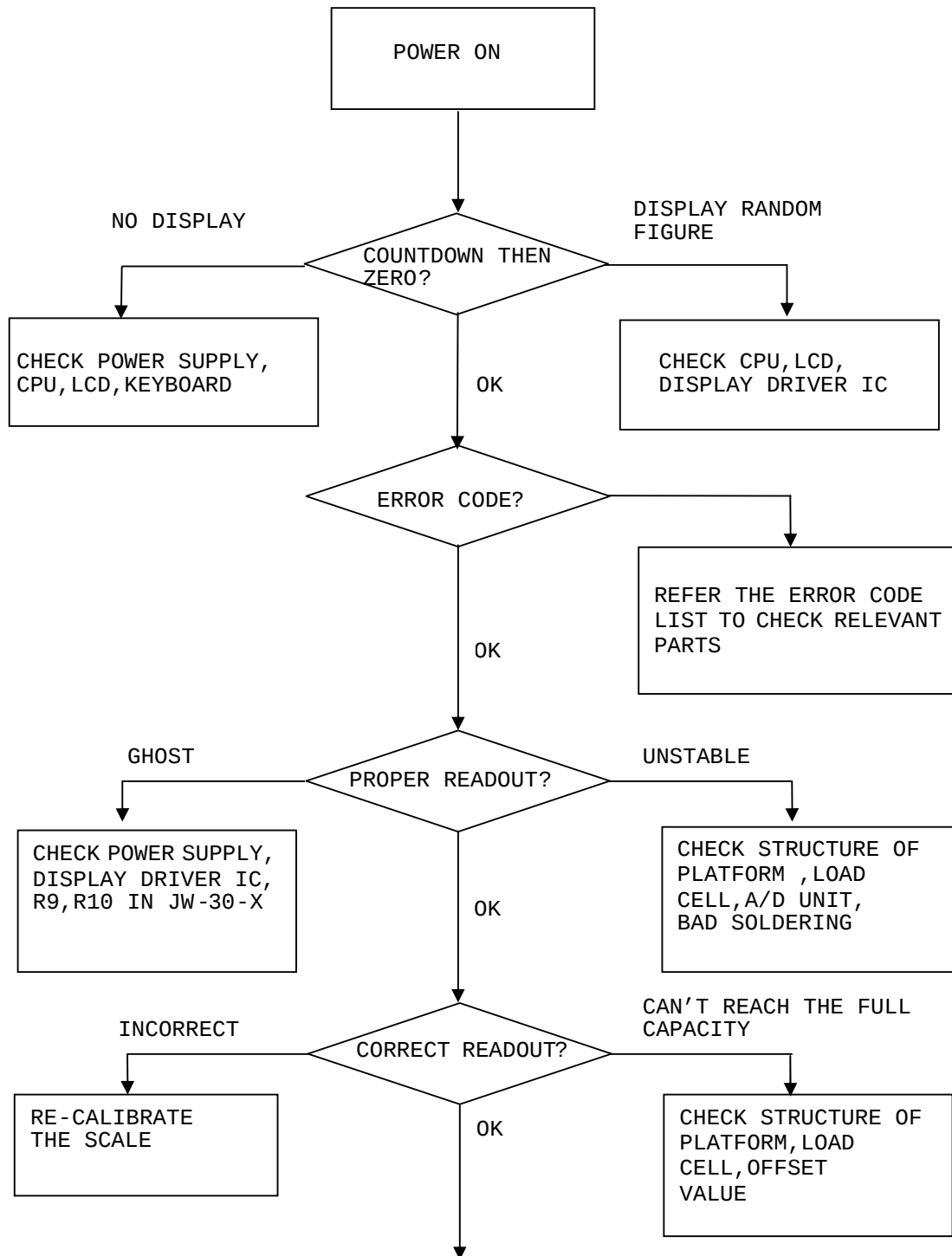
13. Scale will automatically exit the calibration procedure when it is calibrated.

14. Scale now reads the weight of the load on the platter.

Note : *Auto calibration can only be performed when the span value is within +/-10% tolerance of dealer calibration.*

3. TROUBLE SHOOTING

3.1 TROUBLE SHOOTING LOOP



NORMAL OPERATION

3.2 PARTS AND COMPONENTS TROUBLE SHOOTING

3.2.1 Power Supply Checking

3.2.1.1 Relevant parts:

Main Board (JW-10-X)

DC JACK

Q1 (C1061)

Q2 (C945)

Q3 (C945)

Q4 (A1515)

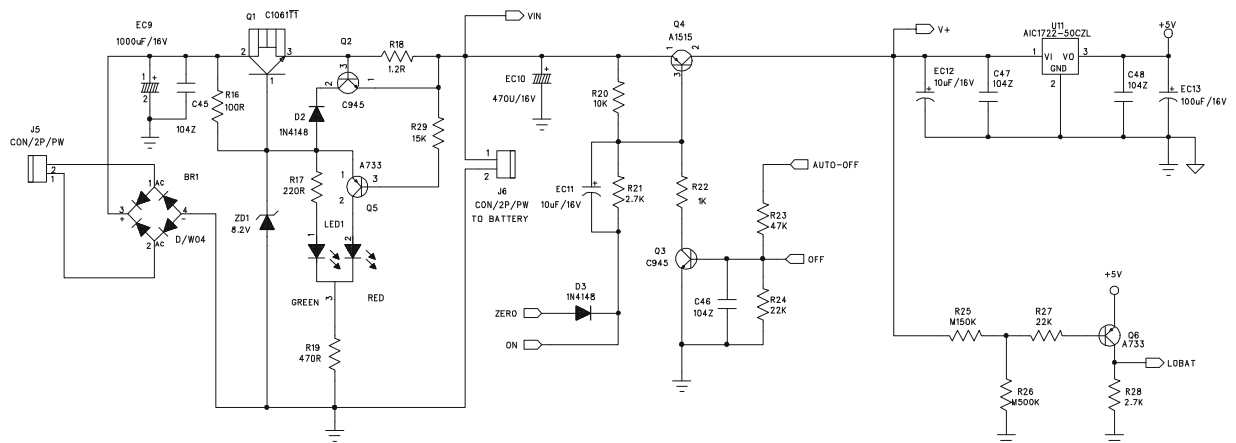
Q6 (A733)

U11 (AIC 1722-5.0)

R18 (1.2R 1/2W)

ZD1 (ZENER 8.2V)

BATTERY (6V 3Ah)



Description:

- 1) Power source: Rechargeable Battery 6V/3Ah or AC adaptor (9V, 500mA)
- 2) How Battery is charged completely?
The charging voltage is regulated by Q1 (C1061) and ZD1 (8.2V) for about 7 volts.

The charging current will go down automatically when voltage reached.
Q2 (C945) and R18 (1.2R, 1/2W) provide Over-Current protection.

- 3) +5V power drives digital circuit system.
U11 (AIC 1722-5.0) is a 5volts Voltage Regulator.
- 4) +5V power drives analog circuit system.
U5 (NS2950A) is a 5volts Voltage Regulator.
- 5) Auto-off:
If the scale is set with 30_off or even under LO-BAT situation, after fixed time interval, CPU will release a low potential signal to draw down Q3, then Q4 cuts off, the scale will be shut down immediately.
- 6) Low Power Detection:
The Q6(A733) is designed to detect the power level. When battery power is less than 5.5V, the collector pole will become high potential, then CPU will instruct LCD display to show LO-BAT symbol.

3.2.1.2 Input voltage: 5.5V or higher

Check and recharge battery if voltage is less than 5.5V.

3.2.1.3 System voltage (Vcc): 5V +/- 10%

Check that the system voltage is within 5V +/- 10%

- a) less than 4.5V, the CPU may not work properly.
- b) more than 6V, ghost will appear on LCD.

3.2.2 Platform Stopper Checking

The platform device shall not touch anything around itself during operation. Check that the platform is not contacted with the upper (no load) and/or lower (with load) stopper.

3.2.3 LCD Display Checking

3.2.3.1 Check that it is soldered and connected properly between LCD and driver IC (PCF8576), driver IC (PCF8576) and CPU.

3.2.3.2 Check whether LCD is broken.

3.2.4 CPU Checking

3.2.4.1 Check that all pins are seated properly into the socket.

3.2.4.2 Check that the Crystal Oscillator works.

3.2.4.3 Check the RESET is normally low.

3.2.5 A/D Unit Checking

3.2.5.1 Check that the +5V powers are correctly fed to the A/D unit.

3.2.5.2 Check that the signal output of loadcell is normal.

3.2.5.3 Check OP. Amplifiers & A/D Converter (AD7730).

When no error is found with the above checking procedures, the trouble can be caused on the load cell or the PCB itself. Replace a new one could be better to identify the defective.

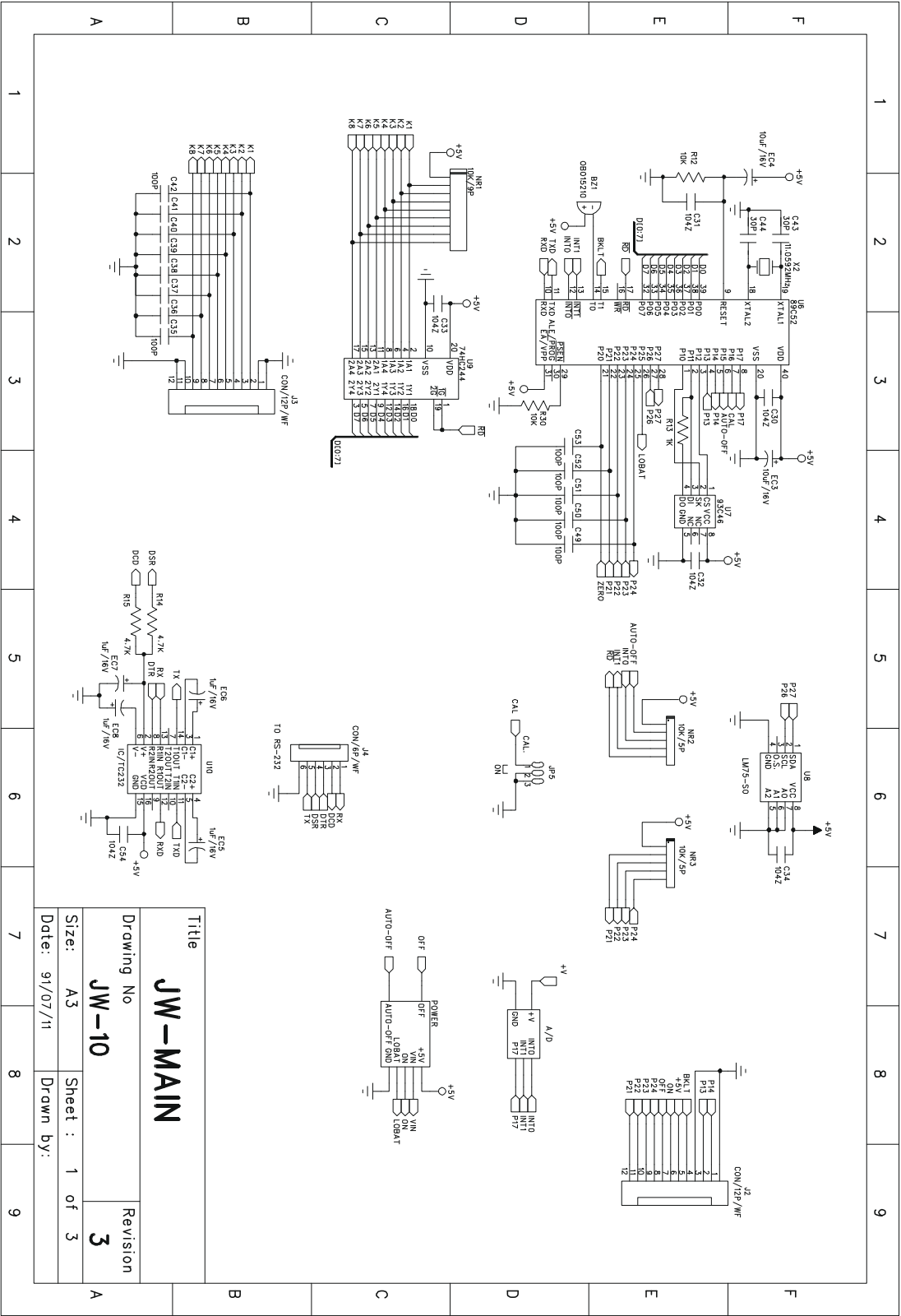
In this way, the readout of weight would be varied because of the output voltage of load cell and different span value, so re-calibration is required after this replacement.

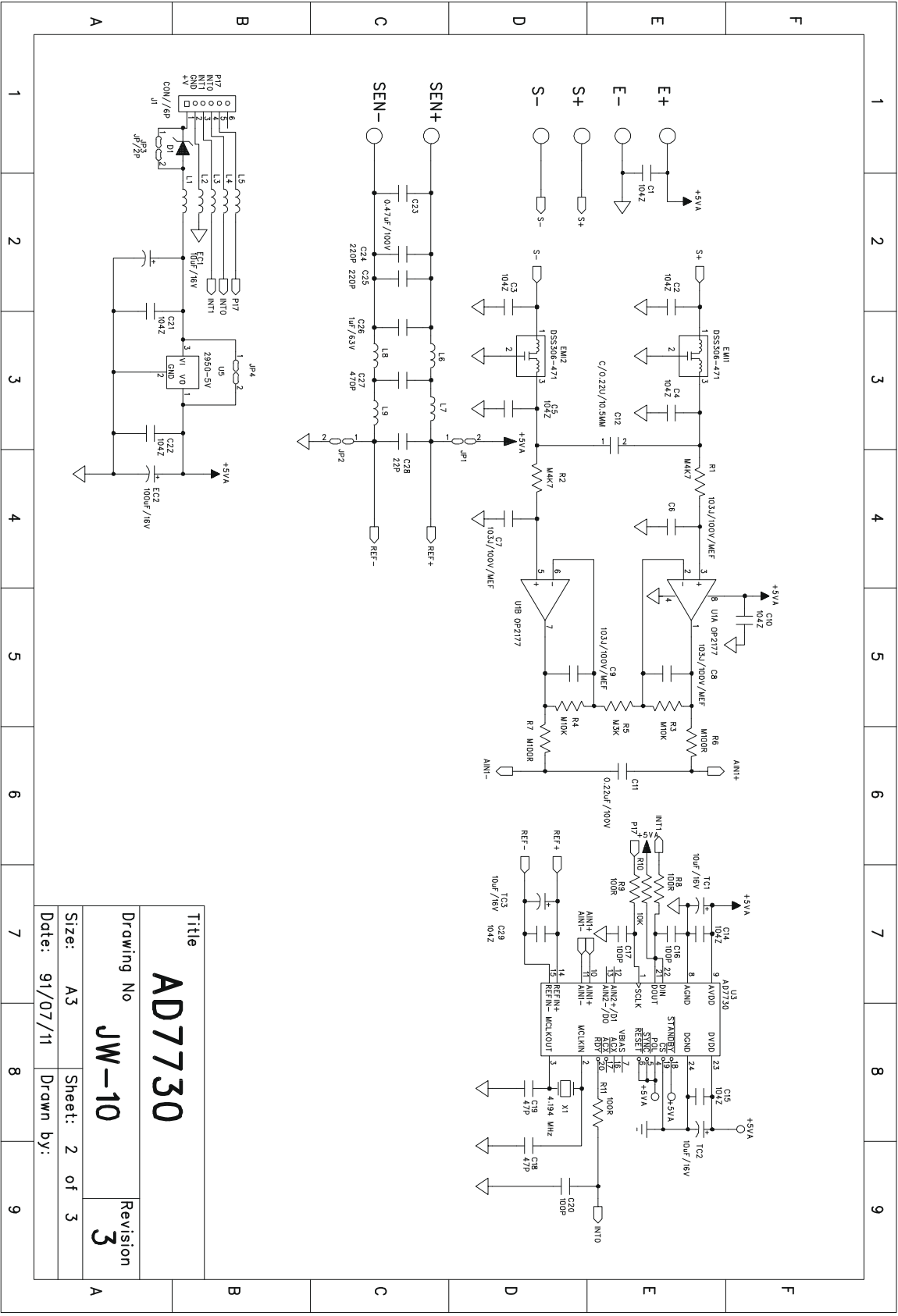
3.2.6 ERROR CODES AND DESCRIPTIONS

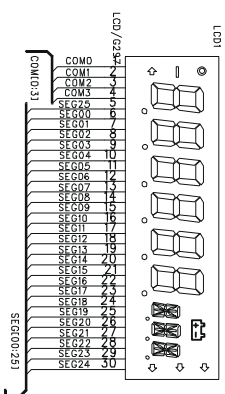
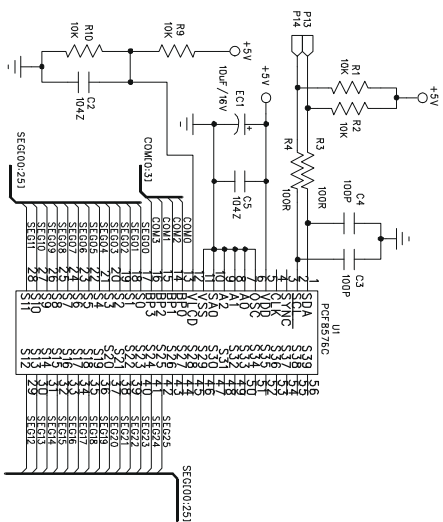
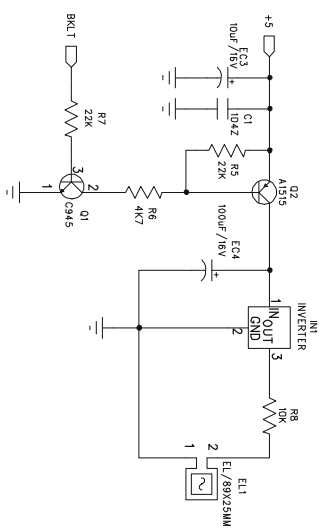
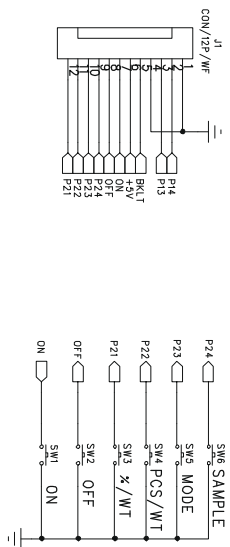
ERROR CODE	DESCRIPTION
000000 -----	Excess weight over full capacity
Err_ov	Span value too high during calibration
----- 000000	Negative weight over weighable range

4.ELECTRICAL CIRCUITRY

4.1 SCHEMATICS

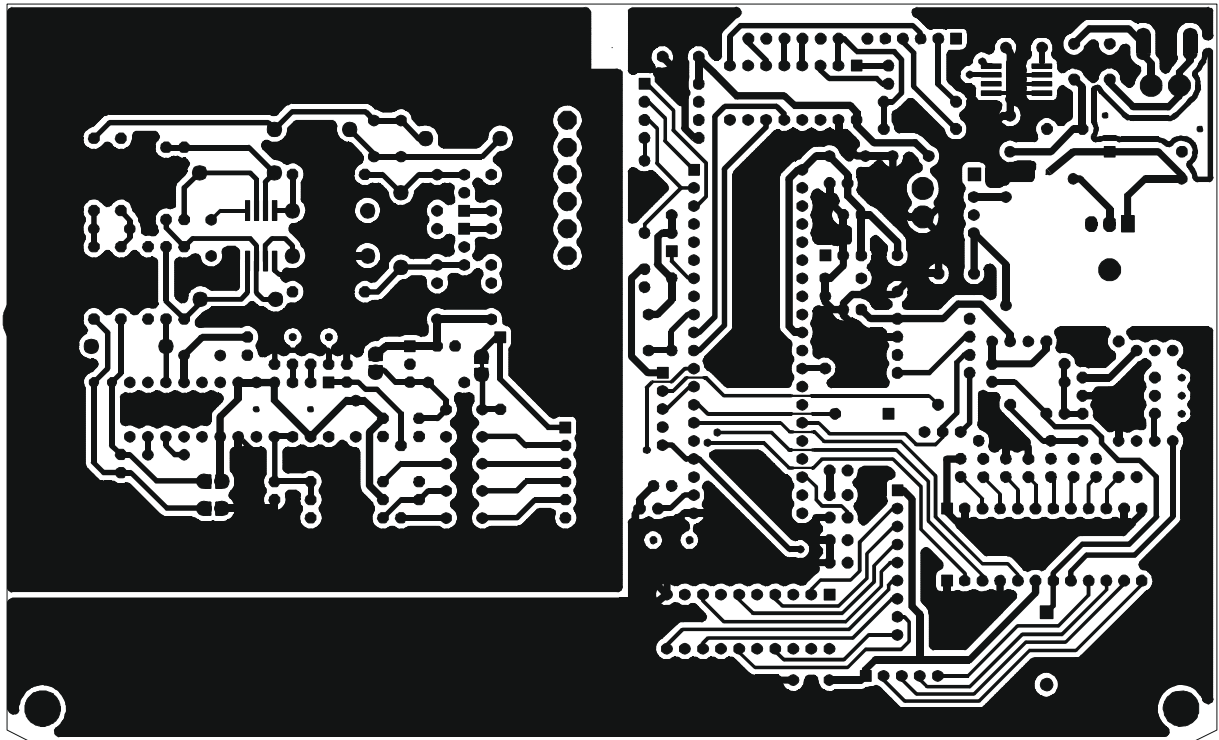




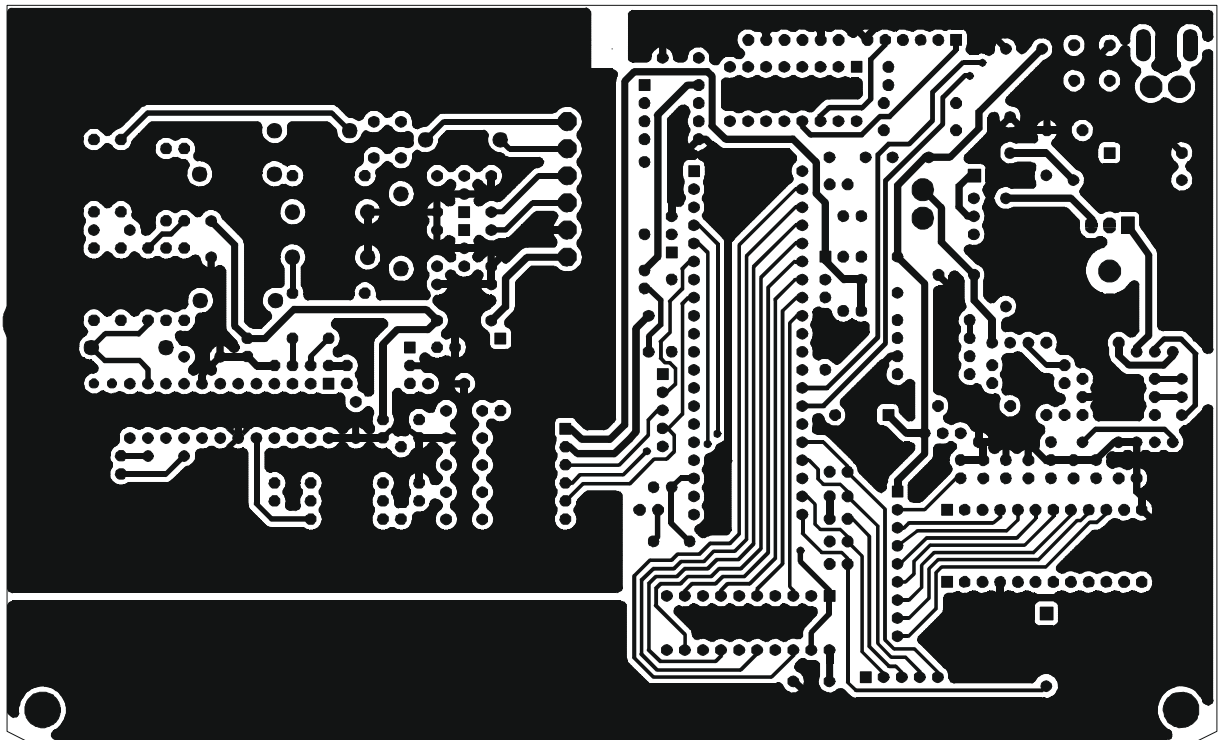


Title		
JW-DISPLAY		
Drawing No		Revision
JW-30		2
Size:	A3	Sheet: 1 of 1
Date:	9/1/04/29	Drawn by:

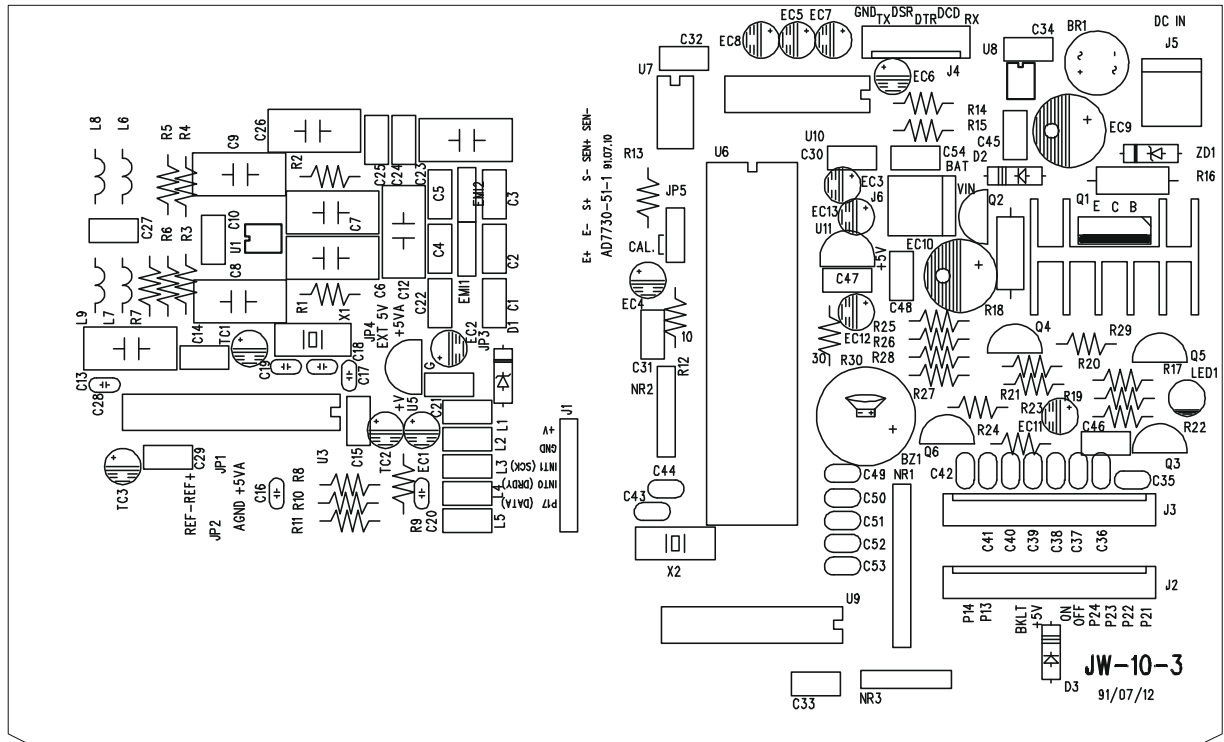
4.2 PCB LAYOUT



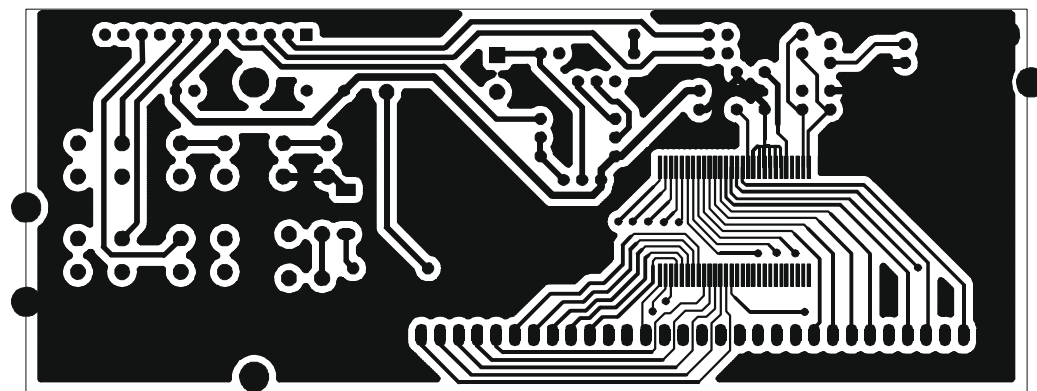
JW-10-3 TOP LAYER



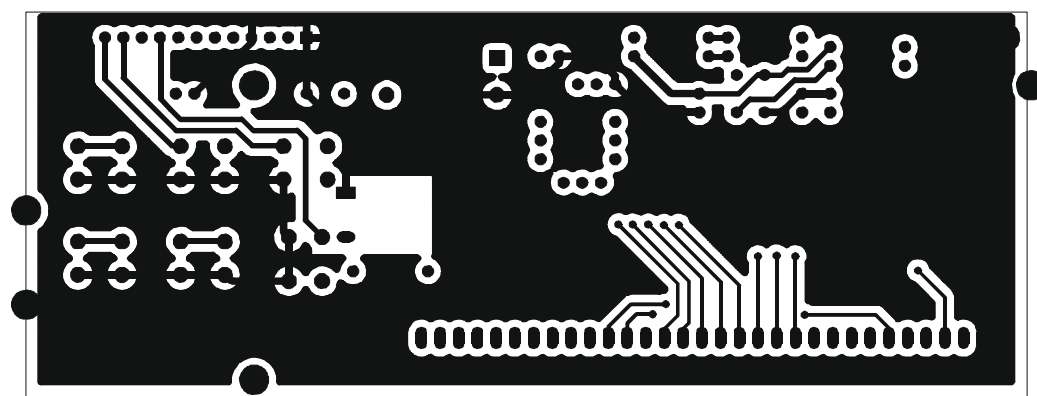
JW-10-3 BOTTOM LAYER



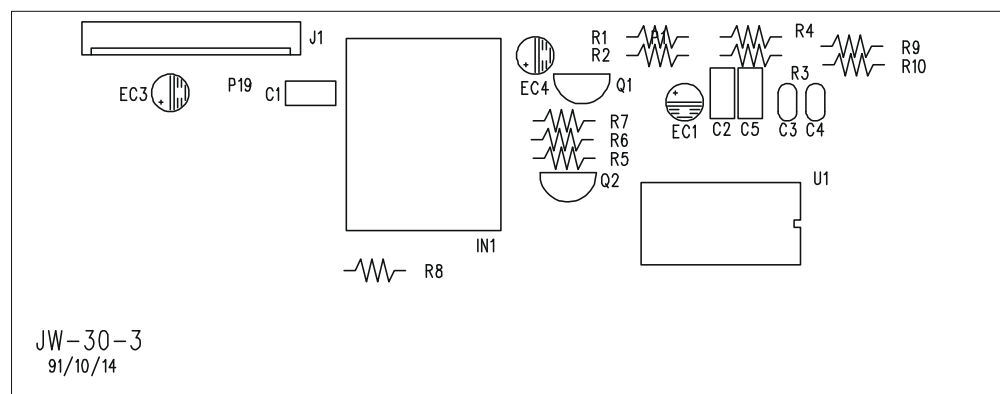
JW-10-3 TOP OVERLAY



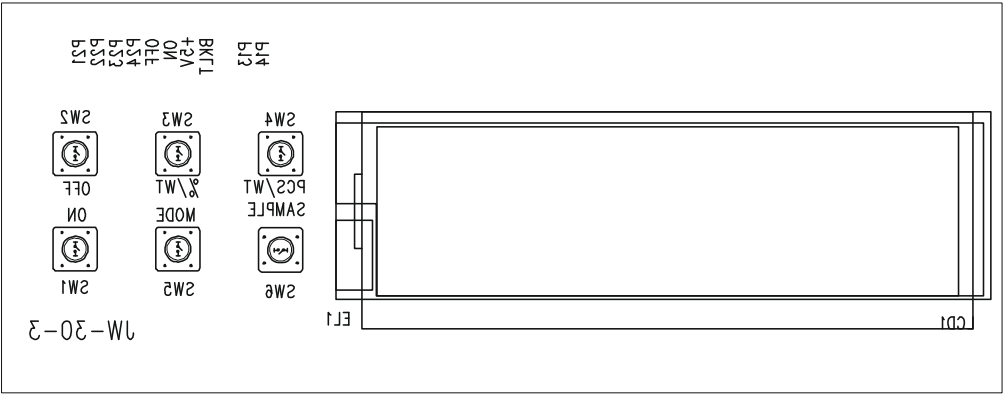
JW-30-3 TOP LAYER



JW-30-3 BOTTOM LAYER



JW-30-3 TOP OVERLAY



JW-30-3 BOTTOM OVERLAY

5. BILL OF MATERIAL

STRUCTURE

Parts No.	Description	Specification	Qty	Remark
A0905600400	CONNECTOR	PLT-164-R	1	OPTION
A1001000150	TRANSFORMER	W50	1	
A1003010301	EMI FILTER	03AB1	1	
A1304000001	SLIDE SW.	SY-14-H04, 3 PIN	1	
A1307000001	VOLTAGE SELECTOR	3 PIN, 230V/115V	1	
A5005000001	MICA	T0-92	2	
A5005000010	ISOLATION BUSH	T0-220A	2	
C1W50031000	K/B OVERLAY	W50 SERIES	1	
C1W50030000	PANEL OVERLAY	W50 SERIES	1	
E1W5000001X	P.C.B.	W50-10-X	1	MAINBOARD
E1W5000010X	P.C.B.	W50-30-X	1	DISPLAY
F0005W50000	ALUMINUM HOUSING	ALUMINUM HOUSING	1	
F0005W50100	STEEL BACK PANEL	W50 SERIES, 186*91*0.8t	1	
F0007W50000	STEEL FIXING PLATE	W50 SERIES, DISPLAY	2	
F0011W50000	S/S MOUNTING PLATE	W50 SERIES, HOUSING	2	
G0001W50100	PLASTIC DISPLAY FRAME	W50 SERIES	1	
Z0010000205	SCREW(ROUND HEAD)	M2*0.4P*5L	2	
Z0010001308	SCREW(TAPPED)	M3*8	6	
Z0010000308	SCREW(ROUND HEAD)	M3*0.5P*8L	4	
Z0010000306	SCREW(ROUND HEAD)	M3*0.5P*5L	4	
Z0011000308	SCREW(FLAT HEAD)	M3*0.5P*8L	2	
Z0015000410	SCREW	M4*0.7P*10L	8	
Z0015000415	SCREW	M4*0.7P*15L	2	
Z0016000003	NUT	M3*0.5P	4	
HW4000000005	JUNCTION BOX	JB-W40-5	1	4 CHANNELS
HW4000000007	JUNCTION BOX	JB-W40-7	1	6 CHANNELS
HW4000000009	JUNCTION BOX	JB-W40-9	1	8 CHANNELS

W50-10-X MAINBOARD

E0W50000010	P.C.B.	W50-10-X	1	
A0201080321	I.C.	80C32	1	U10
A0202024021	I.C.	AT24C02	1	U9
A0202062640	I.C.	HM6264	1	U13
A0202275121	I.C.	27C512	1	U12
A0203002322	I.C.	MAX232CPE	1	U2
A0204074002	I.C.	74HC00	1	U14
A0204074060	I.C.	7406	1	U5
A0204741382	I.C.	74HC138	1	U15
A0204742452	I.C.	74HC245	1	U16
A0204745732	I.C.	74HC573	1	U11
A0206003930	I.C.	LM393	1	U7
A0207078050	VOLTAGE REGULATOR I.C.	7805	1	RG2
A0207078180	VOLTAGE REGULATOR I.C.	7818	1	RG1
A0250013020	I.C.	DS1302	1	U8
A0300000028	I.C. SOCKET	28 PIN	1	U12
A0401009450	TRANSISTOR	2SC945	2	Q1, Q2
A0403008170	PHOTO COUPLER	K817P	1	U6
A0501004148	DIODE	1N4148	4	D1, 4-5, 7
A0502000001	BRIDGE RECTIFIER	W06(1A)	3	BG1-3
A0503020030	ZENER DIODE	1/2W 3V	2	ZD1-2

A0503020068	ZENER DIODE	1/2W 6V8	1	ZD3
A0503020350	ZENER DIODE	1/2W 35V	1	ZD4
A0701106017	CAPACITOR (EC)	10uF/16V (SS TYPE)	4	C6-9
A0701108025	CAPACITOR (EC)	1000uF/25V	2	C4-5
A0701227050	CAPACITOR (EC)	220uF/50V	1	C3
A0701228035	CAPACITOR (EC)	2200uF/35V	1	C1
A0701478016	CAPACITOR (EC)	4700uF/16V	1	C2
A0702106016	CAPACITOR (TC)	10uF/16V	1	C21
A0730104050	CAPACITOR (MLC)	104Z	20	C10-16, 20, 22-29, 35-38
A0740020050	CAPACITOR (CC)	20pF	2	C17-18
A0740101050	CAPACITOR (CC)	100pF(101)	8	P_C1-8
A0804040075	METAL FILM RESISTOR	7.5Ω 1/4W	1	R9
A0804041002	METAL FILM RESISTOR	10KΩ 1/4W	1	R6
A0804044701	METAL FILM RESISTOR	4.7KΩ 1/4W	1	R5
A0805041101	CARBON FILE RESISTOR	100Ω 1/4W	8	P_R1-8
A0805041102	CARBON FILE RESISTOR	1KΩ 1/4W	2	R1, 7
A0805041103	CARBON FILE RESISTOR	10KΩ 1/4W	5	R11, 16, 18, 23, 15
A0805041104	CARBON FILE RESISTOR	100KΩ 1/4W	1	R12
A0805041221	CARBON FILE RESISTOR	220Ω 1/4W	2	R2, 4
A0805041203	CARBON FILE RESISTOR	20KΩ 1/4W	1	R43
A0805041222	CARBON FILE RESISTOR	2.2KΩ 1/4W	1	R8
A0805041561	CARBON FILE RESISTOR	560Ω 1/4W	2	R3, 10
A0902010090	CONNECTOR	9 PIN WAFER, PITCH=3.9mm	1	PW_SW1
A0904121090	CONNECTOR	D-SUB 9PIN(FEMALE)	2	C_L/C1, C_SER1
A0904121250	CONNECTOR	D-SUB 25PIN(FEMALE)	1	PRN1
A1004140471	SURGE ABSORBOR	14K 471	1	TNR1
A1100032768	CRYSTAL	32.768KHZ	1	X2
A1100311059	CRYSTAL	11.0952MHZ	1	X1
A1500000004	BUZZER	OB0-15210	1	BZ1
A1602036003	Ni-Cd BATTERY	UM-3, 1.2V*3	1	
A5002000521	FUSE	250V/500mA	1	F1
A5003000004	FUSE HOLDER(P.C.B. MOUNT)	CQ-203P (1.2)	1	F1

W50-30-X DISPLAY BOARD

E0W50000100	P.C.B.	W50-30-X	1	
A0101430601	TUBE	VFD43-0601	1	DISP1
A0204742372	I.C.	74HC237	2	U18, 20
A0204743672	I.C.	74HC367	1	U21
A0208061180	I.C.	UDN 6118A	2	U17, 19
A0501004148	DIODE	1N4148	2	D2, 6
A0730104050	CAPACITOR (MLC)	104Z	5	C30-34
A0805041103	CARBON FILE RESISTOR	10KΩ 1/4W	4	R19-22
A1306000003	TACT SW	KPT-1104B	8	K1-8

=====

6 . APPENDIX
PARTS EXPLOSION:

ITEM	PARTS NO.	DESCRIPTION	SPECIFICATION	QTY
2	F0005W50000	ALUMINUM HOUSING	ALUMINUM HOUSING	1
4	F0007W50000	STEEL FIXING PLATE	W50 SERIES, DISPLAY	2
6	Z0010000308	SCREW(ROUND HEAD)	M3*0.5P*8L	4
7	Z0015000410	SCREW	M4*0.7P*10L	8
8	G0001W50100	PLASTIC DISPLAY FRAME	W50 SERIES	1
10	C1W50030000	PANEL OVERLAY	W50 SERIES	1
12	C1W50031000	K/B OVERLAY	W50 SERIES	1
14	E0W50000100	P.C.B.	W50-30-X	1
16	Z0010001308	SCREW(TAPPED)	M3*8	6
18	Z0010000306	SCREW(ROUND HEAD)	M3*0.5P*5L	4
20	E0W50000010	P.C.B.	W50-10-X	1
22	F0005W50100	STEEL BACK PANEL	W50 SERIES, 186*91*0.8t	1
24		SCREW	1/8-40 UNC	6
26	Z0016000003	NUT	M3*0.5P	4
28	A0905600400	CONNECTOR	PLT-164-R	1
30	A1304000001	SLIDE SW.	SY-14-H04, 3 PIN	1
32	Z0010000205	SCREW(ROUND HEAD)	M2*0.4P*5L	2
34	A1307000001	VOLTAGE SELECTOR	3 PIN, 230V/115V	1
36	A1003010301	EMI FILTER	03AB1	1
38	Z0011000308	SCREW(FLAT HEAD)	M3*0.5P*8L	2
40	F0011W50000	S/S MOUNTING PLATE	W50 SERIES, HOUSING	2
42	Z0015000415	SCREW	M4*0.7P*15L	2



Product List

SM8958L25, 25 MHz 32KB internal memory MCU
SM8958C25, 25 MHz 32KB internal memory MCU
SM8958C40, 40 MHz 32KB internal memory MCU

Description

The SM8958 series product is an 8 - bit single chip micro controller with 32KB flash & 1KB RAM embedded. It is a derivative of the 8052 micro controller family. With its hardware features and powerful instruction set, it's straight forward to make it a versatile and cost effective controller for those applications which demand up to 32 I/O pins for PDIP package or up to 36 I/O pins for PLCC/QFP package, or applications which need up to 32KB memory either for program or for data or mixed. To program the on-chip flash memory, a commercial writer is available to do it in parallel programming method.

Ordering Information

yywww
SM8958ihhk

yy: year, ww:week
v: version identifier { A, B,...}
i: process identifier {L=3.0V ~ 3.6V, C=4.5V ~ 5.5V}
hh: working clock in MHz {25, 40}
k: package type postfix {as below table}

Postfix	Package	Pin/Pad Configuration	Dimension
P	40L PDIP	page 2	page15
J	44L PLCC	page 2	page16
Q	44L QFP	page 2	page17

Features

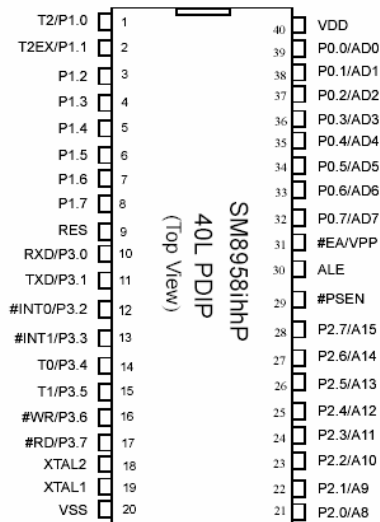
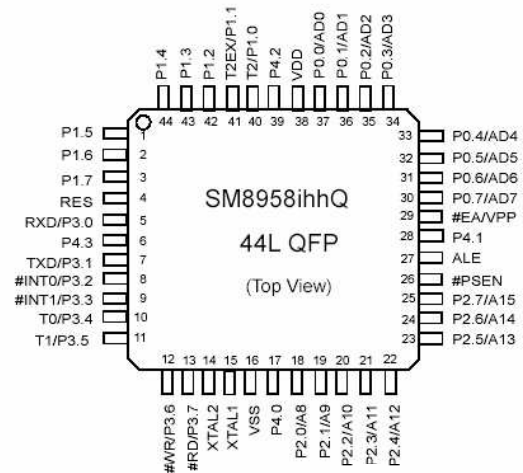
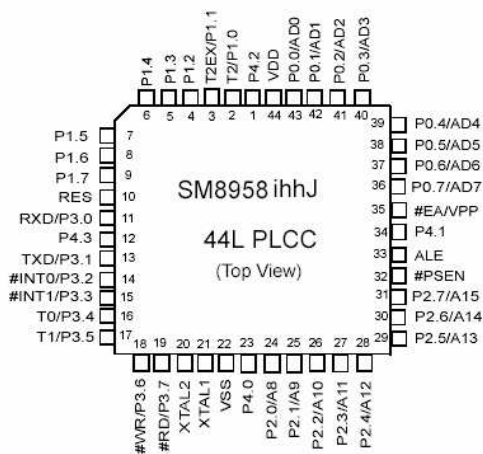
- Working voltage: 3.0V ~ 3.6V For L Version
4.5V ~ 5.5V For C Version
- General 8052 family compatible
- 12 clocks per machine cycle
- 32 KB internal flash memory
- 1024 bytes data RAM
- 3 16 bit timers/counters
- Four 8-bit I/O ports for PDIP package
- Four 8-bit I/O ports + one 4-bit I/O ports for PLCC or QFP package
- Full duplex serial channel
- Bit operation instruction
- Page free jumps
- 8-bit unsigned division
- 8-bit unsigned multiply
- BCD arithmetic operations
- Direct addressing
- Indirect addressing
- Nested interrupts
- Two priority level interrupts
- A serial I/O port
- Power save modes:
Idle mode and power down mode
- Code protection function
- One watch dog timer (WDT)
- Low EMI (inhibit ALE)

Taiwan
4F, No. 1 Creation Road 1,
Science-based Industrial Park,
Hsinchu, Taiwan 30077

TEL: 886-3-579-2926
886-3-579-2988
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886-3-578-0493



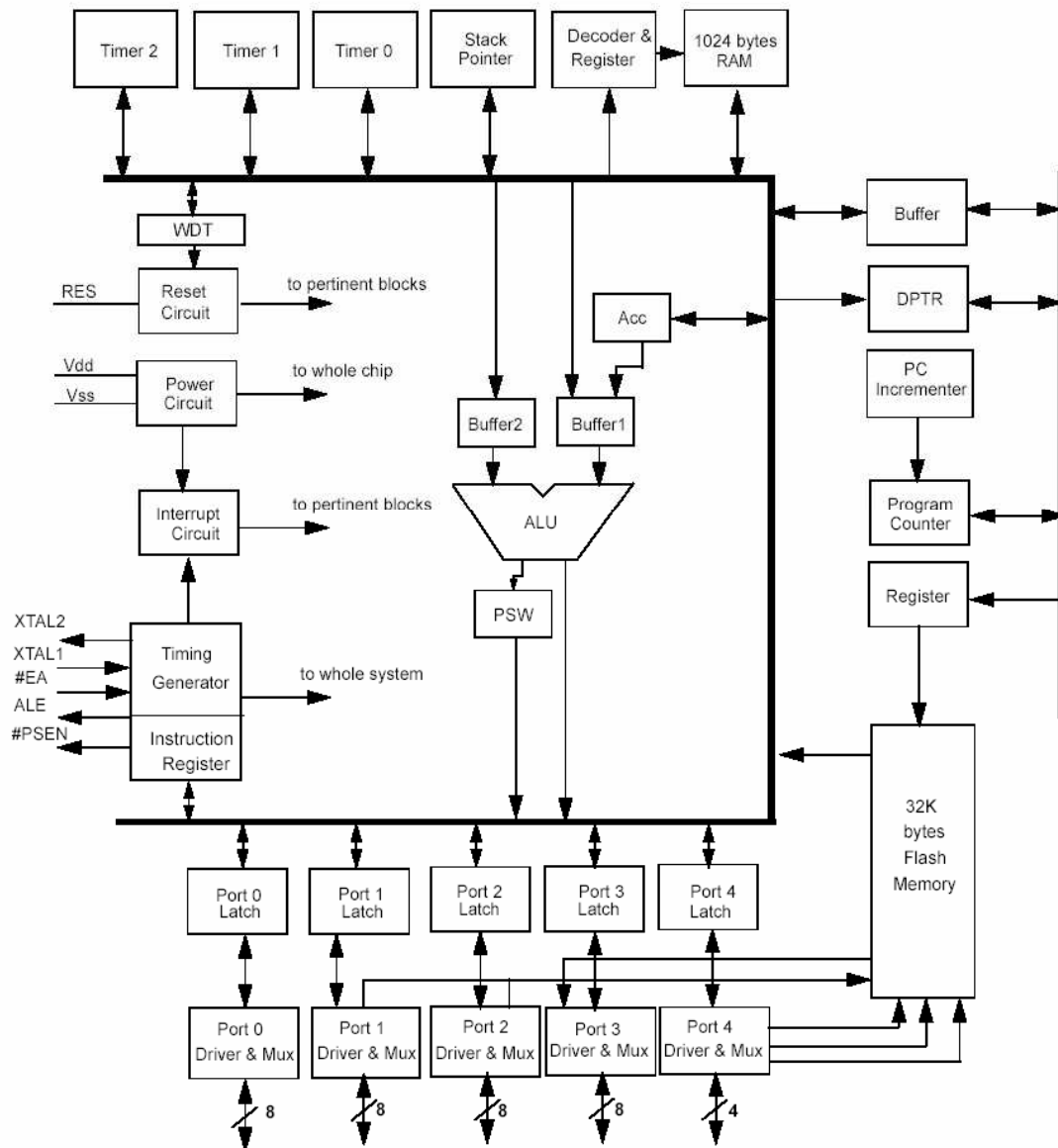
Pin Configurations



Specifications subject to change without notice, contact your sales representatives for the most recent information.



Block Diagram



Specifications subject to change without notice, contact your sales representatives for the most recent information.



AD7730/AD7730L

Operates with Reference Voltages of 1 V to 5 V

Single Supply Operation

Pressure Measurement

The AD7730 is available in a 24-pin plastic DIP, a 24-lead SOIC and 24-lead TSSOP package. The AD7730L is available in a 24-lead SOIC and 24-lead TSSOP package.

The description of the functions and operation given in this data sheet apply to both the AD7730 and AD7730L. Specifications and performance parameters differ for the parts. Specifications for the AD7730L are outlined in Appendix A.

The block diagram of the AD7730 shows the following components and connections:

- Power and Reference Pins:** AVDD, DVDD, REF IN(-), REF IN(+), AGND, DGND, POL, RDY, RESET.
- Input/Output Pins:** VBIAS, AIN1(+), AIN1(-), AIN2(+)/D1, AIN2(-)/D0, ACX, ACX, MCLK IN, MCLK OUT, SCLK, CS, DIN, DOUT, STANDBY, SYNC.
- Internal Blocks:**
 - REFERENCE DETECT:** Connected to REF IN(+).
 - SIGMA-DELTA A/D CONVERTER:** Contains a SIGMA-DELTA MODULATOR and a PROGRAMMABLE DIGITAL FILTER.
 - PGA (Programmable Gain Amplifier):** Receives input from the MUX and provides feedback to the 6-BIT DAC.
 - 6-BIT DAC:** Provides feedback to the PGA.
 - SERIAL INTERFACE AND CONTROL LOGIC:** Manages data flow and control signals.
 - CLOCK GENERATION:** Generates internal clock signals from MCLK IN.
 - REGISTER BANK:** Stores configuration data, accessible via SCLK, CS, DIN, and DOUT.
 - CALIBRATION MICROCONTROLLER:** Manages calibration data, accessible via POL, RDY, and RESET.
 - AC EXCITATION CLOCK:** Provides an external clock for the AC excitation circuit.
- Signal Flow:** Input signals (AIN1, AIN2) pass through a MUX to the PGA. The PGA output is filtered by a 100nA current source and a 6-BIT DAC before being converted by the SIGMA-DELTA A/D CONVERTER. The output is then sent to the REGISTER BANK and the SERIAL INTERFACE AND CONTROL LOGIC.

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Tel: 781/329-4700 World Wide Web Site: <http://www.analog.com>
Fax: 781/326-8703 © Analog Devices, Inc., 1998

AD7730—SPECIFICATIONS

($AV_{DD} = +5\text{ V}$, $DV_{DD} = +3\text{ V}$ or $+5\text{ V}$; REF IN(+) = AV_{DD} ; REF IN(−) = AGND = DGND = 0 V; $f_{CLK\ IN} = 4.9152\text{ MHz}$. All specifications T_{MIN} to T_{MAX} unless otherwise noted.)

Parameter	B Version ¹	Units	Conditions/Comments	
STATIC PERFORMANCE (CHP = 1)				
No Missing Codes ²	24	Bits min	Offset Error and Offset Drift Refer to Both Unipolar Offset and Bipolar Zero Errors	
Output Noise and Update Rates ²	See Tables I & II			
Integral Nonlinearity	18	ppm of FSR max		
Offset Error ²	See Note 3			
Offset Drift vs. Temperature ²	5	nV/°C typ		
Offset Drift vs. Time ⁴	25	nV/1000 Hours typ		
Positive Full-Scale Error ^{2, 5}	See Note 3			
Positive Full-Scale Drift vs Temp ^{2, 6, 7}	2	ppm of FS/°C max		
Positive Full-Scale Drift vs Time ⁴	10	ppm of FS/1000 Hours typ		
Gain Error ^{2, 8}	See Note 3			
Gain Drift vs. Temperature ^{2, 6, 9}	2	ppm/°C max		
Gain Drift vs. Time ⁴	10	ppm/1000 Hours typ		
Bipolar Negative Full-Scale Error ²	See Note 3			
Negative Full-Scale Drift vs. Temp ^{2, 6}	2	ppm of FS/°C max		
Power Supply Rejection	120	dB typ	Measured with Zero Differential Voltage At DC. Measured with Zero Differential Voltage	
Common-Mode Rejection (CMR)	120	dB min		
Analog Input DC Bias Current ²	50	nA max		
Analog Input DC Bias Current Drift ²	100	pA/°C typ		
Analog Input DC Offset Current ²	10	nA max		
Analog Input DC Offset Current Drift ²	50	pA/°C typ		
STATIC PERFORMANCE (CHP = 0) ²				
No Missing Codes	24	Bits min	SKIP = 0 ¹⁰	
Output Noise and Update Rates	See Tables III & IV			
Integral Nonlinearity	18	ppm of FSR max		
Offset Error	See Note 3			
Offset Drift vs. Temperature ⁶	0.5	µV/°C typ		
Offset Drift vs. Time ⁴	2.5	µV/1000 Hours typ		
Positive Full-Scale Error ⁵	See Note 3			
Positive Full-Scale Drift vs. Temp ^{6, 7}	0.6	µV/°C typ		
Positive Full-Scale Drift vs. Time ⁴	3	µV/1000 Hours typ		
Gain Error ⁸	See Note 3			
Gain Drift vs. Temperature ^{6, 9}	2	ppm/°C typ		
Gain Drift vs. Time ⁴	10	ppm/1000 Hours typ		
Bipolar Negative Full-Scale Error	See Note 3			
Negative Full-Scale Drift vs. Temp	0.6	µV/°C typ		
Power Supply Rejection	90	dB typ	Measured with Zero Differential Voltage At DC. Measured with Zero Differential Voltage At DC. Measured with Zero Differential Voltage	
Common-Mode Rejection (CMR) on AIN	100	dB typ		
CMR on REF IN	120	dB typ		
Analog Input DC Bias Current	60	nA max		
Analog Input DC Bias Current Drift	150	pA/°C typ		
Analog Input DC Offset Current	30	nA max		
Analog Input DC Offset Current Drift	100	pA/°C typ		
ANALOG INPUTS/REFERENCE INPUTS				
Normal-Mode 50 Hz Rejection ²	88	dB min	From 49 Hz to 51 Hz	
Normal-Mode 60 Hz Rejection ²	88	dB min		From 59 Hz to 61 Hz
Common-Mode 50 Hz Rejection ²	120	dB min	From 49 Hz to 51 Hz	
Common-Mode 60 Hz Rejection ²	120	dB min	From 59 Hz to 61 Hz	
Analog Inputs				
Differential Input Voltage Ranges ¹¹			Assuming 2.5 V or 5 V Reference with HIREF Bit Set Appropriately	
	0 to +10 or ±10	mV nom		Gain = 250
	0 to +20 or ±20	mV nom		Gain = 125
	0 to +40 or ±40	mV nom		Gain = 62.5
	0 to +80 or ±80	mV nom		Gain = 31.25
Absolute/Common-Mode Voltage ¹²				
	AGND + 1.2 V	V min	HIREF Bit of Mode Register = 0 HIREF Bit of Mode Register = 1	
	AV _{DD} – 0.95 V	V max		
Reference Input				
REF IN(+) – REF IN(–) Voltage	+2.5	V nom		
REF IN(+) – REF IN(–) Voltage	+5	V nom		
Absolute/Common-Mode Voltage ¹³				
	AGND – 30 mV	V min	NO REF Bit Active If V _{REF} Below This Voltage NO REF Bit Inactive If V _{REF} Above This Voltage	
	AV _{DD} + 30 mV	V max		
NO REF Trigger Voltage	0.3	V min		
	0.65	V max		

Parameter	B Version ¹	Units	Conditions/Comments
LOGIC INPUTS			
Input Current	±10	μA max	
All Inputs Except SCLK and MCLK IN			
V _{INL} , Input Low Voltage	0.8	V max	DV _{DD} = +5 V
V _{INL} , Input Low Voltage	0.4	V max	DV _{DD} = +3 V
V _{INH} , Input High Voltage	2.0	V min	
SCLK Only (Schmitt Triggered Input)			
V _{T+}	1.4/3	V min to V max	DV _{DD} = +5 V
V _{T+}	1/2.5	V min to V max	DV _{DD} = +3 V
V _{T-}	0.8/1.4	V min to V max	DV _{DD} = +5 V
V _{T-}	0.4/1.1	V min to V max	DV _{DD} = +3 V
V _{T+} - V _{T-}	0.4/0.8	V min to V max	DV _{DD} = +5 V
V _{T+} - V _{T-}	0.4/0.8	V min to V max	DV _{DD} = +3 V
MCLK IN Only			
V _{INL} , Input Low Voltage	0.8	V max	DV _{DD} = +5 V
V _{INL} , Input Low Voltage	0.4	V max	DV _{DD} = +3 V
V _{INH} , Input High Voltage	3.5	V min	DV _{DD} = +5 V
V _{INH} , Input High Voltage	2.5	V min	DV _{DD} = +3 V
LOGIC OUTPUTS (Including MCLK OUT)			
V _{OL} , Output Low Voltage	0.4	V max	I _{SINK} = 800 μA Except for MCLK OUT ¹⁴ ; V _{DD} ¹⁵ = +5 V
V _{OL} , Output Low Voltage	0.4	V max	I _{SINK} = 100 μA Except for MCLK OUT ¹⁴ ; V _{DD} ¹⁵ = +3 V
V _{OH} , Output High Voltage	4.0	V min	I _{SOURCE} = 200 μA Except for MCLK OUT ¹⁴ ; V _{DD} ¹⁵ = +5 V
V _{OH} , Output High Voltage	V _{DD} - 0.6 V	V min	I _{SOURCE} = 100 μA Except for MCLK OUT ¹⁴ ; V _{DD} ¹⁵ = +3 V
Floating State Leakage Current	±10	μA max	
Floating State Output Capacitance ²	6	pF typ	
TRANSDUCER BURNOUT			
AIN1(+) Current	-100	nA nom	
AIN1(-) Current	100	nA nom	
Initial Tolerance @ 25°C	±10	% typ	
Drift ²	0.1	%/°C typ	
OFFSET (TARE) DAC			
Resolution	6	Bit	
LSB Size	2.3/2.6	mV min/mV max	2.5 mV Nominal with 5 V Reference (REF IN/2000)
DAC Drift ¹⁶	2.5	ppm/°C max	
DAC Drift vs. Time ^{4, 16}	25	ppm/1000 Hours typ	
Differential Linearity	-0.25/+0.75	LSB max	Guaranteed Monotonic
SYSTEM CALIBRATION			
Positive Full-Scale Calibration Limit ¹⁷	1.05 × FS	V max	FS Is the Nominal Full-Scale Voltage (10 mV, 20 mV, 40 mV or 80 mV)
Negative Full-Scale Calibration Limit ¹⁷	-1.05 × FS	V max	
Offset Calibration Limit ¹⁸	-1.05 × FS	V max	
Input Span ¹⁷	0.8 × FS	V min	
	2.1 × FS	V max	
POWER REQUIREMENTS			
Power Supply Voltages			
AV _{DD} - AGND Voltage	+4.75 to +5.25	V min to V max	
DV _{DD} Voltage	+2.7 to +5.25	V min to V max	
Power Supply Currents			
AV _{DD} Current (Normal Mode)	10.3	mA max	With AGND = 0 V
AV _{DD} Current (Normal Mode)	22.3	mA max	External MCLK. Digital I/Ps = 0 V or DV _{DD}
DV _{DD} Current (Normal Mode)	1.3	mA max	All Input Ranges Except 0 mV to +10 mV and ±10 mV
DV _{DD} Current (Normal Mode)	2.7	mA max	Input Ranges of 0 mV to +10 mV and ±10 mV Only
AV _{DD} + DV _{DD} Current (Standby Mode)	25	μA max	DV _{DD} of 2.7 V to 3.3 V
Power Dissipation			DV _{DD} of 4.75 V to 5.25 V
Normal Mode	65	mW max	Typically 10 μA. External MCLK IN = 0 V or DV _{DD}
	125	mW max	AV _{DD} = DV _{DD} = +5 V. Digital I/Ps = 0 V or DV _{DD}
Standby Mode	125	μW max	All Input Ranges Except 0 mV to +10 mV and ±10 mV
			Input Ranges of 0 mV to +10 mV and ±10 mV Only
			Typically 50 μW. External MCLK IN = 0 V or DV _{DD}

AD7730/AD7730L

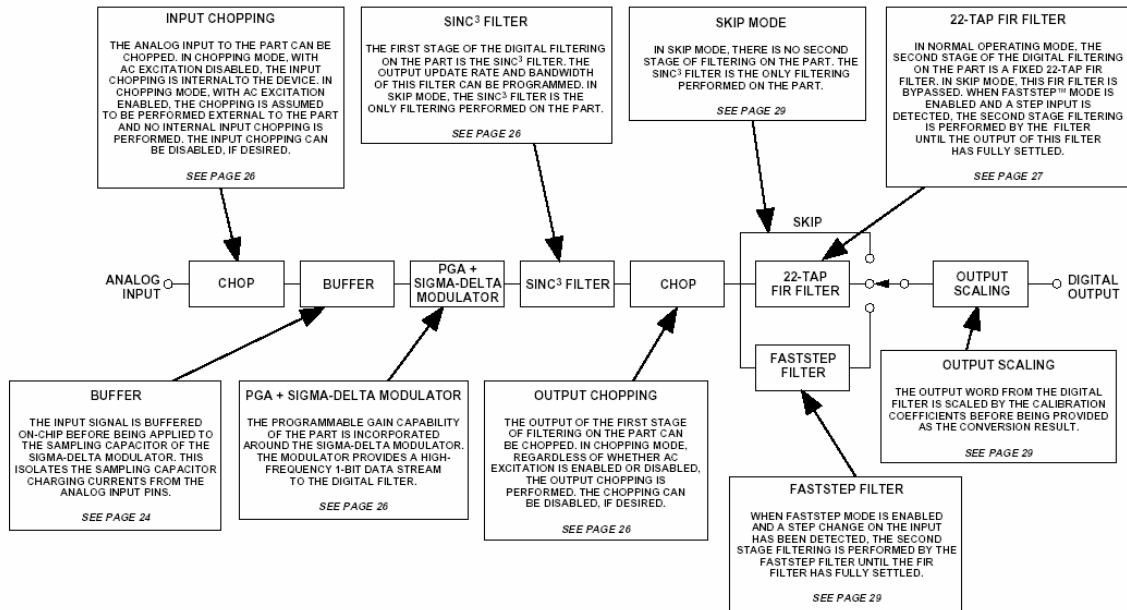
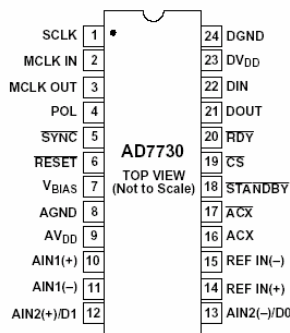


Figure 3. Signal Processing Chain

PIN CONFIGURATION



PIN FUNCTION DESCRIPTIONS

Pin No.	Mnemonic	Function
1	SCLK	Serial Clock. Schmitt-Triggered Logic Input. An external serial clock is applied to this input to transfer serial data to or from the AD7730. This serial clock can be a continuous clock with all data transmitted in a continuous train of pulses. Alternatively, it can be a noncontinuous clock with the information being transmitted to or from the AD7730 in smaller batches of data.
2	MCLK IN	Master Clock signal for the device. This can be provided in the form of a crystal/resonator or external clock. A crystal/resonator can be tied across the MCLK IN and MCLK OUT pins. Alternatively, the MCLK IN pin can be driven with a CMOS-compatible clock and MCLK OUT left unconnected. The AD7730 is specified with a clock input frequency of 4.9152 MHz while the AD7730L is specified with a clock input frequency of 2.4576 MHz.

Universal LCD driver for low multiplex rates

PCF8576

1 FEATURES

- Single-chip LCD controller/driver
- Selectable backplane drive configuration: static or 2/3/4 backplane multiplexing
- Selectable display bias configuration: static, $\frac{1}{2}$ or $\frac{1}{3}$
- Internal LCD bias generation with voltage-follower buffers
- 40 segment drives: up to twenty 8-segment numeric characters; up to ten 15-segment alphanumeric characters; or any graphics of up to 160 elements
- 40 × 4-bit RAM for display data storage
- Auto-incremented display data loading across device subaddress boundaries
- Display memory bank switching in static and duplex drive modes
- Versatile blinking modes
- LCD and logic supplies may be separated
- Wide power supply range: from 2 V for low-threshold LCDs and up to 9 V for guest-host LCDs and high-threshold (automobile) twisted nematic LCDs
- Low power consumption
- Power-saving mode for extremely low power consumption in battery-operated and telephone applications
- I²C-bus interface
- TTL/CMOS compatible
- Compatible with any 4-bit, 8-bit or 16-bit microprocessors/microcontrollers



- May be cascaded for large LCD applications (up to 2560 segments possible)
- Cascadable with 24-segment LCD driver PCF8566
- Optimized pinning for plane wiring in both single and multiple PCF8576 applications
- Space-saving 56-lead plastic very small outline package (VSO56)
- Very low external component count (at most one resistor, even in multiple device applications)
- Compatible with chip-on-glass technology
- Manufactured in silicon gate CMOS process.

2 GENERAL DESCRIPTION

The PCF8576 is a peripheral device which interfaces to almost any Liquid Crystal Display (LCD) with low multiplex rates. It generates the drive signals for any static or multiplexed LCD containing up to four backplanes and up to 40 segments and can easily be cascaded for larger LCD applications. The PCF8576 is compatible with most microprocessors/microcontrollers and communicates via a two-line bidirectional I²C-bus. Communication overheads are minimized by a display RAM with auto-incremented addressing, by hardware subaddressing and by display memory switching (static and duplex drive modes).

3 ORDERING INFORMATION

TYPE NUMBER	PACKAGE		
	NAME	DESCRIPTION	VERSION
PCF8576T	VSO56	plastic very small outline package; 56 leads	SOT190-1
PCF8576U	—	chip in tray	—
PCF8576U/2	—	chip with bumps in tray	—
PCF8576U/5	—	unsawn wafer	—
PCF8576U/10	FFC	chip on film frame carrier (FFC)	—
PCF8576U/12	FFC	chip with bumps on film frame carrier (FFC)	—

